

FIG. 1A

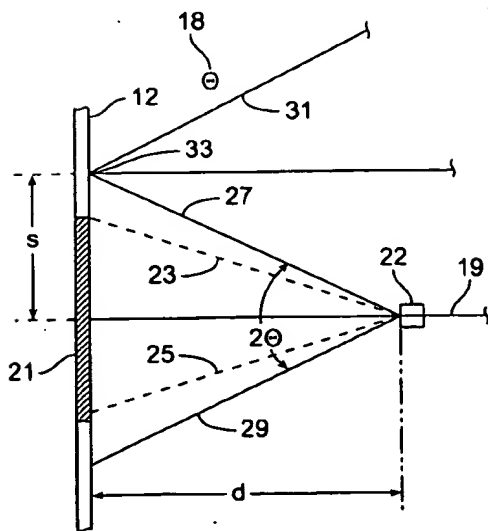
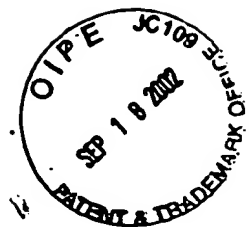


FIG. 1B

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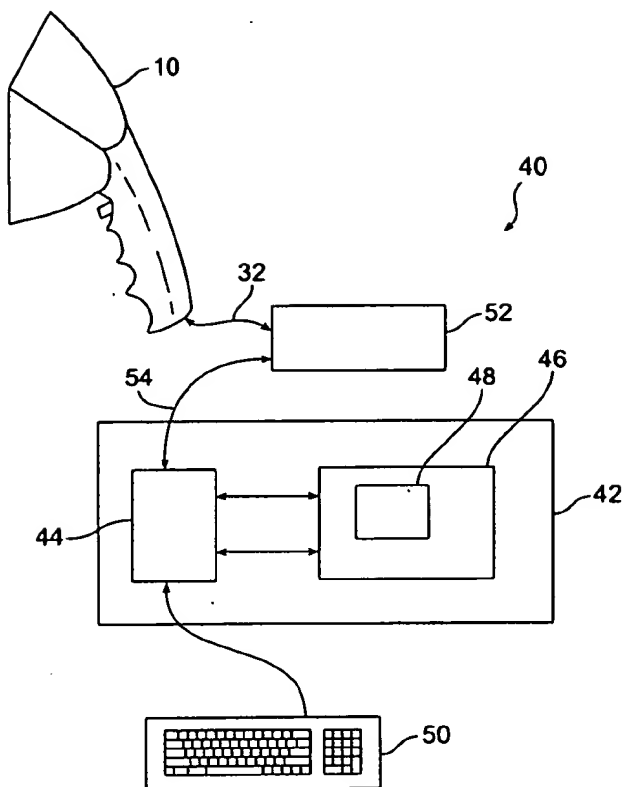


FIG. 1C

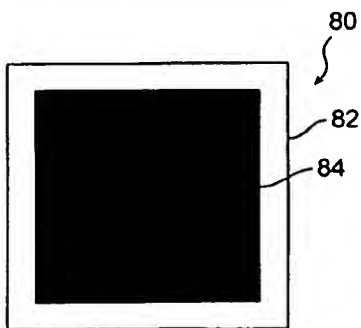
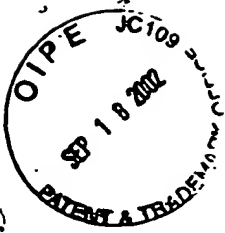


FIG. 2A

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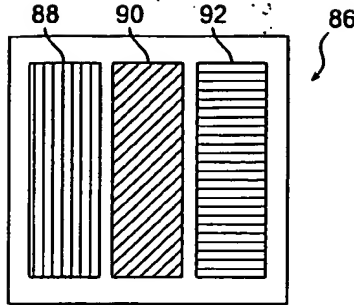


FIG. 2B

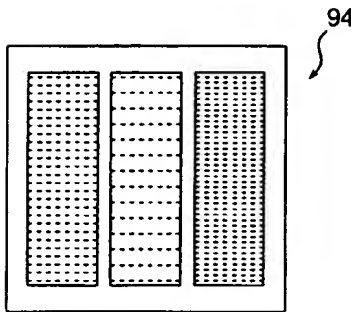


FIG. 2C

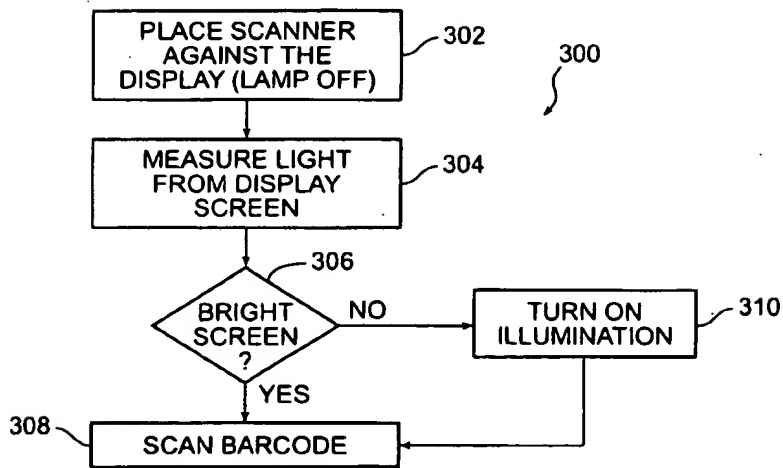


FIG. 3A

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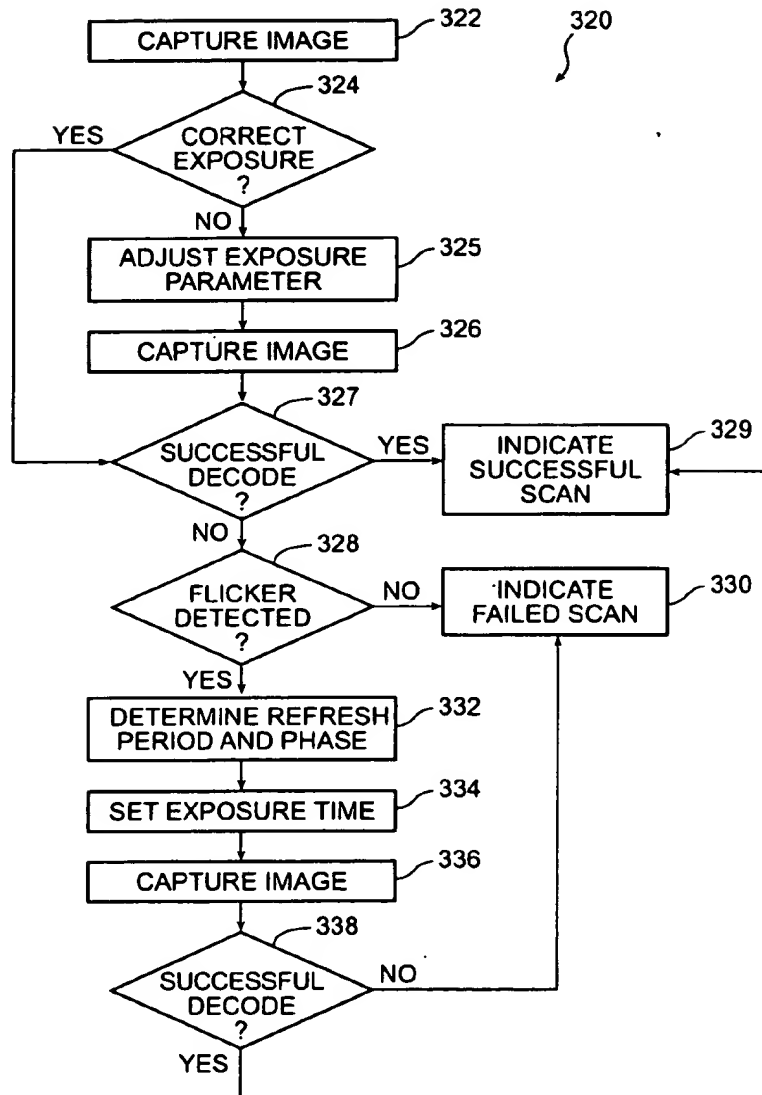
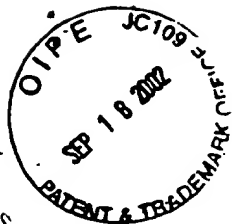


FIG. 3B

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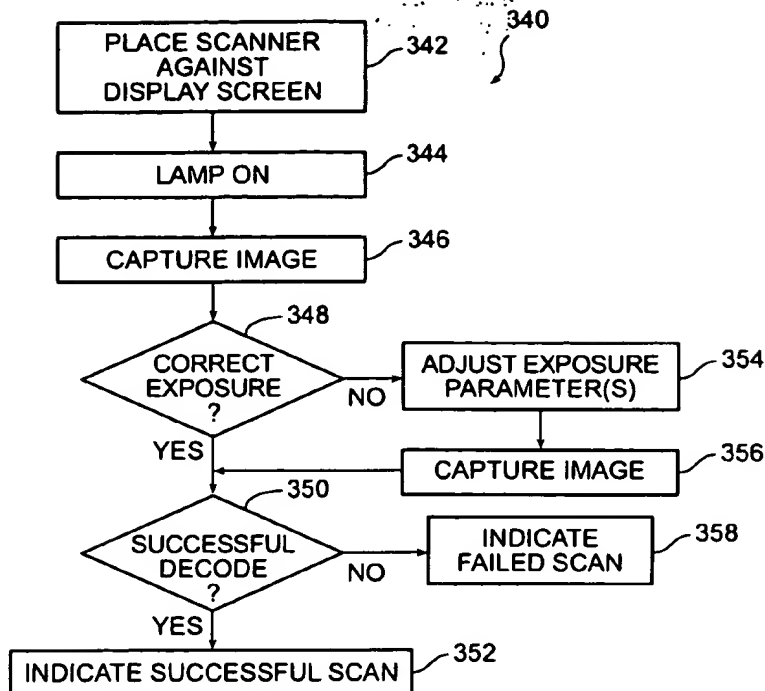


FIG. 3C

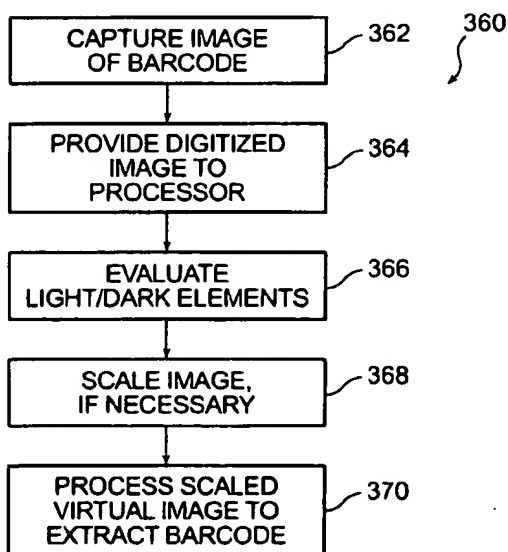


FIG. 3D

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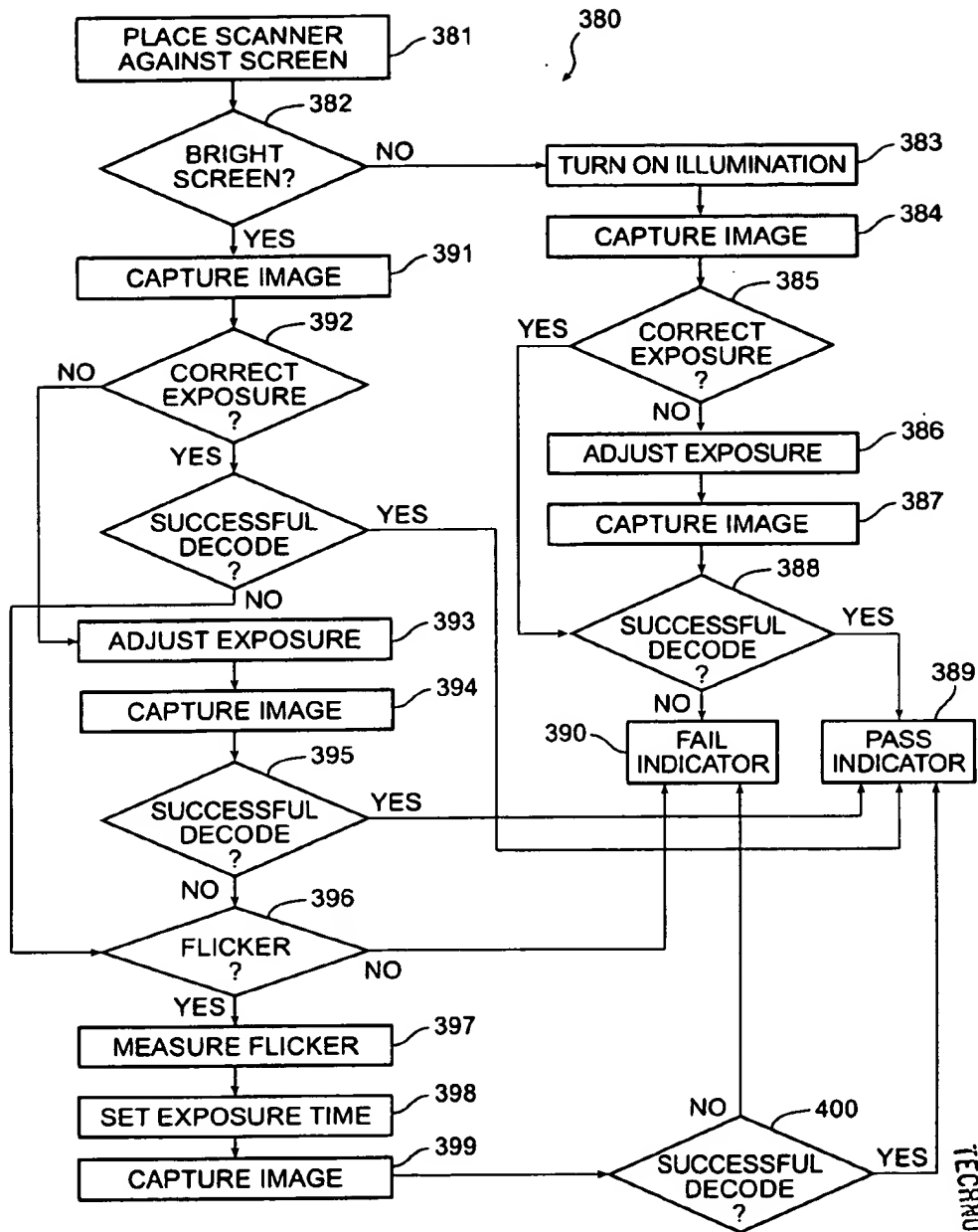


FIG. 3E

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